

Specification for TFT

AFY1280800A1-10.1INTH

Revision A

| Α | Orient Display |
|---------|---|
| FY | TFT Type |
| 1280800 | Resolution 1280 x 800 |
| A1 | Serial A1 |
| 10.1 | 10.1", Module Dimension 228.85x152.74x4.25 mm |
| 1 | IPS Display |
| N | Top: -20~+70°C; Tstr: -30~+80°C |
| Т | Transmissive |
| Н | High Brightness, 1000 cd/m2 |
| / | No Touch Panel |
| / | EK79202B OR COMPATIBLE |
| 1 | LVDS interface |













REVISION RECORD

| Rev No. | Contents | Prepared | Rev date |
|---------|--|------------|------------|
| 0 | First release | TaoXing Mo | 2023-02-10 |
| А | CHANGE THE RELIABILITY TEST CONDITIONS Update BACKLIGHT CHARACTERISTICS Update RELIABILITY TEST CONDITIONS | TaoXing Mo | 2023-03-22 |
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1. GENERAL INFORMATION

| No. | Item | Contents | Unit |
|-----|--------------------------------|---------------------------------|------|
| 1 | LCD size | 10.1 inch (Diagonal) | 1 |
| 2 | Display mode | IPS/NORMALLY BLACK/Transmissive | 1 |
| 3 | Viewing direction(eye) | FREE | 1 |
| 4 | Gray scale inversion direction | - | 1 |
| 5 | Resolution(H*V) | 1280*800 Pixels | / |
| 6 | Module size (L*W*H) | 228.85*152.74*4.25 | mm |
| 7 | Active area (L*W) | 216.96*135.60 | mm |
| 8 | Pixel pitch (L*W) | 0.1695*0.1695 | mm |
| 9 | Interface type | LVDS interface | 1 |
| 10 | Color Depth | 16.7M | 1 |
| 11 | Module power consumption | TBD(Appr) | W |
| 12 | Back light type | EDGE&WHITE LED | 1 |
| 13 | Driver IC | EK79202B OR COMPATIBLE | 1 |
| 14 | Weight | TBD(Appr) | G |

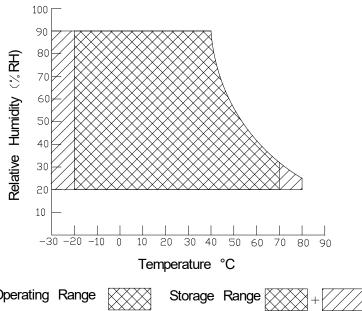
2. ABSOLUTE MAXIMUM RATINGS

| Item | Symbol | Min. | Max. | Unit | Note |
|------------------------------------|--------|------|------|------|-------|
| Power supply input voltage for TFT | VDD | -0.5 | 4.0 | V | |
| Backlight current (normal temp.) | ILED | - | 225 | mA | |
| Operation temperature | Тор | -20 | +70 | °C | Note1 |
| Storage temperature | Tst | -30 | +80 | °C | Note1 |
| Humidity | RH | 20% | 90% | RH | Note1 |

Note1:

1). The relative humidity and temperature range are as below sketch, 90%RH Max.

2). The maximum wet bulb temperature ≤40°C and without dewing.



Operating Range

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3. ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS(at Ta=25°C)

| Item | Symbol | Min. | Тур. | Max. | Unit | Note |
|--|-------------------|--------|-------|--------|------|-------------------------|
| Power supply input voltage(TFT Module) | VDD | 2.3 | 2.5 | 2.7 | V | |
| Input voltage 'H' level | VIH | 0.8VDD | - | VDD | V | |
| Input voltage 'L' level | VIL | VSS | - | 0.2VDD | V | |
| Power supply current | IVDD | - | TBD | - | mA | |
| TFT gate on voltage | VGH | 14.5 | 15.0 | 15.5 | V | |
| TFT gate off voltage | VGL | -13.5 | -13.0 | -12.5 | V | |
| Analog power supply voltage | AVDD | 8.0 | 8.2 | 8.4 | V | |
| Differential input common mode voltage | Vcom | - | - | - | V | Note1 |
| LVDS Differential input high Threshold voltage | Rxvтн | - | - | +100 | mV | D1 2\/ |
| LVDS Differential input low Threshold voltage | R _{XVTL} | -100 | - | - | mV | R _{XVCM} =1.2V |
| LVDS Differential input common mode voltage | Rxvсм | 0.7 | - | 1.6 | V | |
| LVDS Differential voltage | [VID] | 200 | - | 600 | mV | |

Note1: The value is just the reference value. VCOM must be adjusted to optimize display quality, as Crosstalk and Contrast Ratio etc..

4. BACKLIGHT CHARACTERISTICS

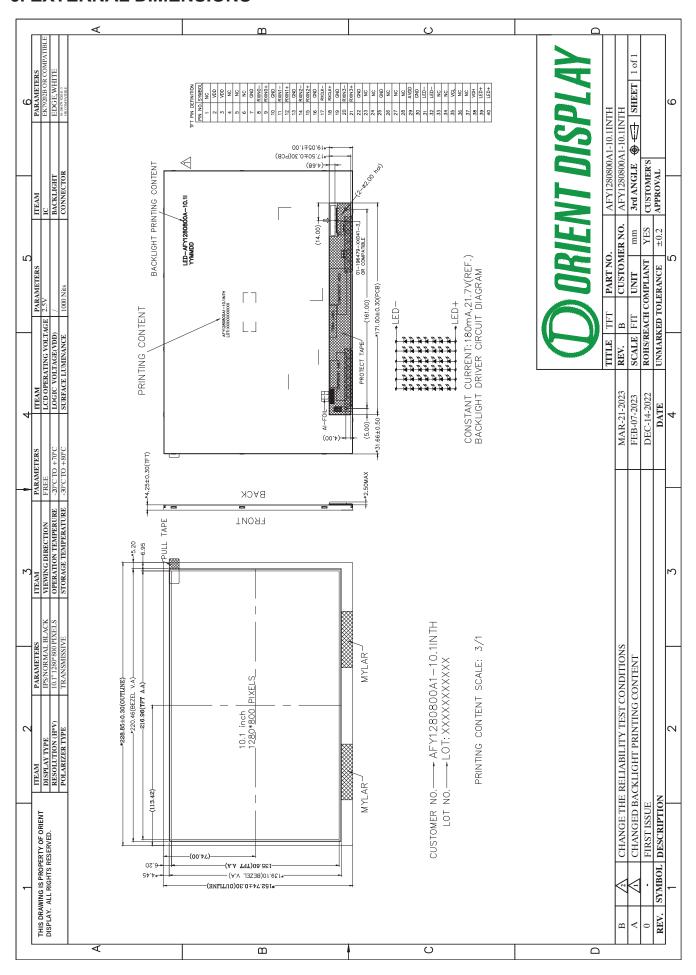
(at Ta=25°C,RH=60%)

| Item | Symbol | Min. | Тур. | Max. | Unit | Note |
|-----------------------|--------|---------------------------|-------|------|------|-----------|
| LED forward voltage | VF | 18.9 | 21.7 | 23.1 | V | |
| LED forward current | IF | - | 180 | - | mA | IF=30*6mA |
| LED power consumption | PLED | - | 3.906 | - | W | Note1 |
| Number of LED | - | | 42 | | PCS | |
| Connection mode | - | 7 in series 6 in parallel | | | 1 | _ |
| LED life-time | - | 20000 | - | - | Hrs | Note2 |

Note1 : Calculator value for reference : IF*VF = PLED

Note2: The LED life-time define as the estimated time to 50% degradation of initial brightness at Ta=25°C and IF =40mA. The LED lifetime could be decreased if operating IF is larger than 40mA.

5. EXTERNAL DIMENSIONS



6. ELECTRO - OPTICAL CHARACTERISTICS

| Item | Symbol | Condition | Min. | Тур. | Max. | Unit | Remark | Note | |
|----------------------|---------|---------------|-------|------|-------|-------------------|---------|--------|--------|
| Response time | Tr+ Tf | | - | 25 | 50 | ms | FIG.1 | Note 1 | |
| Contrast ratio | Cr | - | 480 | 640 | - | - | FIG.2 | Note 2 | |
| Surface luminance | Lv | θ=0° | 800 | 1000 | - | cd/m ² | FIG.2 | Note 3 | |
| Luminance uniformity | Yu | θ=0° | 75 | 80 | - | % | FIG.2 | Note 4 | |
| NTSC | - | θ=0° | - | 50 | - | % | FIG.2 | Note 5 | |
| | | ∅=90° | 75 | 85 | - | deg | FIG.3 | Note 6 | |
| Viowing angle | θ | ∅=270° | 75 | 85 | - | deg | FIG.3 | | |
| Viewing angle | | willig aligie | ∅=0° | 75 | 85 | - | deg | FIG.3 | Note 6 |
| | | ∅=180° | 75 | 85 | - | deg | FIG.3 | | |
| | Red x | | | TBD | | - | | | |
| | Red y | | | TBD | | - | | | |
| | Green x | θ=0° | | TBD | | - | | | |
| CIE (x,y) | Green y | Ø=0° | Тур | TBD | Тур | - | FIG.2 | Note 5 | |
| chromaticity | Blue x | ⊤a=25°C | -0.04 | TBD | +0.04 | - | CIE1931 | Note 5 | |
| | Blue y | 1a-25 C | | TBD | | - | | | |
| | White x | | | TBD | | - | | | |
| | White y | | | TBD | | - | | | |

The TFT module should be stabilized at a given temperature for 10 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 10 minutes in a windless room.

Note1. Definition of response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state.

Normally white:Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%.

Normally black: Rise time (Ton) is the time between photo detector output intensity changed from 10% to 90%.

And fall time (T_{OFF}) is the time between photo detector output intensity changed from 90% to 10%.

For additional information see FIG1.

Note2. Definition of contrast ratio

Contrast ratio(Cr) is defined mathematically by the following formula.

For more information see FIG.2.

Contrast ratio= Luminance measured when LCD on the "White" state
Luminance measured when LCD on the "Black" state

Measured at the center area of the LCD

Note3. Definition of surface luminance

Surface luminance is the luminance with all pixels displaying white.

For more information see FIG.2.

Lv = Average Surface Luminance with all white pixels(P1,P2,P3,,Pn)

Note4. Definition of luminance uniformity

The luminance uniformity in surface luminance is determined by measuring luminance at each test position 1 through n, and then dividing the maximum luminance of n points luminance by minimum luminance of n points luminance. For more information see FIG.2.

 $Yu = \frac{\text{Minimum surface luminance with all white pixels (P1,P2,P3,.....,Pn)}}{\text{Maximum surface luminance with all white pixels (P1,P2,P3,.....,Pn)}}$

Note5. Definition of color chromaticity (CIE1931)

CIE (x,y) chromaticity, The x,y value is determined by screen active area center position. For more information see FIG.2.

Note6. Definition of viewing angle

Viewing angle is the angle at which the contrast ratio is greater than 10 angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the display surface. For more information see FIG.3.

For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope or DMS series Instruments or compatible. For contrast ratio, Surface Luminance, Luminance uniformity and

CIE, the testing data is base on CS-2000/BM-7 photo detector or compatible.

FIG.1. The definition of response Time

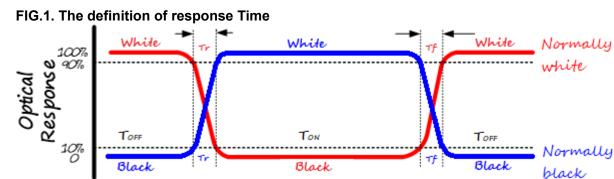


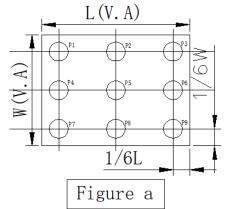
FIG.2. Measuring method for contrast ratio, surface luminance, luminance uniformity, CIE (x,y) chromaticity

H,V: Active area

Light spot size Ø=1.5mm or Ø=7.7mm (CS-2000/BM-7)50cm distance or compatible distance from the LCM surface to detector lens.

Test spot position : see Figure a.

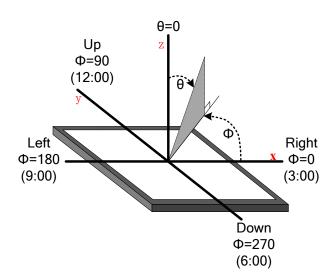
measurement instrument: Luminance meter CS-2000/BM-7 or compatible, see Figure b.



LCD PANE TET MODULE CENTER OF THE SCREEN Figure b

PHOTO DETECTOR

FIG.3. The definition of viewing angle



7. INTERFACE DESCRIPTION

Module Interface description

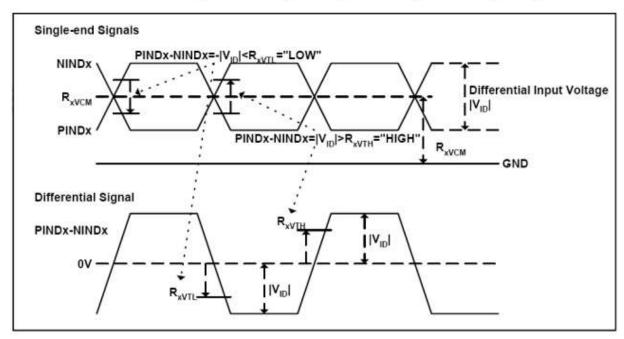
| Interface No. | Name | I/O or connect to | Description |
|---------------|--------|-------------------|--------------------------------|
| 1 | NC | 1 | No connection |
| 2-3 | VDD | Р | Power Supply |
| 4-6 | NC | 1 | No connection |
| 7 | GND | Р | Ground |
| 8 | Rxin0- | I | -LVDS Differential Data Input |
| 9 | Rxin0+ | I | +LVDS Differential Data Input |
| 10 | GND | Р | Ground |
| 11 | Rxin1- | I | -LVDS Differential Data Input |
| 12 | Rxin1+ | 1 | +LVDS Differential Data Input |
| 13 | GND | Р | Ground |
| 14 | Rxin2- | I | -LVDS Differential Data Input |
| 15 | Rxin2+ | 1 | +LVDS Differential Data Input |
| 16 | GND | Р | Ground |
| 17 | RxCLK- | I | -LVDS Differential Clock Input |
| 18 | RxCLK+ | I | +LVDS Differential Clock Input |
| 19 | GND | Р | Ground |
| 20 | Rxin3- | I | -LVDS Differential Data Input |
| 21 | Rxin3+ | I | +LVDS Differential Data Input |
| 22 | GND | Р | Ground |
| 23-24 | NC | 1 | No connection |
| 25 | GND | Р | Ground |
| 26-28 | NC | 1 | No connection |
| 29 | AVDD | Р | Power for Analog Circuit |
| 30 | GND | Р | Ground |
| 31-32 | LED- | Р | LED Cathode |
| 33-34 | NC | 1 | No connection |
| 35 | VGL | Р | Gate OFF Voltage |
| 36-37 | NC | 1 | No connection |
| 38 | VGH | Р | Gate ON Voltage |
| 39-40 | LED+ | Р | LED Anode |

I: input, O: output, P: Power,NC or / : No connection

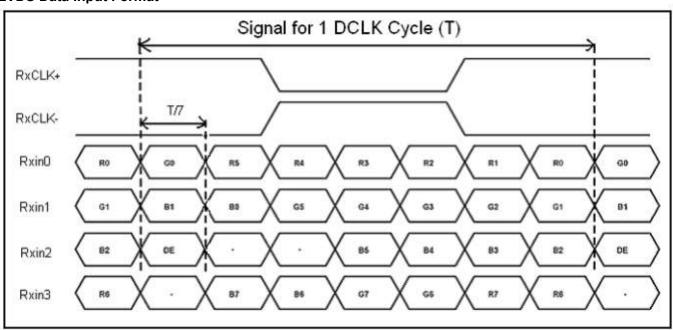
8.AC CHARACTERISTICS

LVDS Signal Timing Characteristics

| Parameter | Symbol | | Values | Unit | Remark | | |
|---|--------------------|------|--------|------|--------|--------------------------|--|
| 1 drameter | Cymbol | Min. | Тур. | Max. | Onic | Itelliark | |
| LVDS Differential input high Threshold voltage | R _{xVTH} | - | 2 | +100 | mV | -R _{XVCM} =1.2V | |
| LVDS Differential input low Threshold voltage | R _{xVTL} | -100 | 2 | - | mV | | |
| LVDS Differential input common mode voltage | R _{xVCM} | 0.7 | | 1.6 | V | | |
| LVDS Differential voltage | [V _{ID}] | 200 | - | 600 | mV | | |

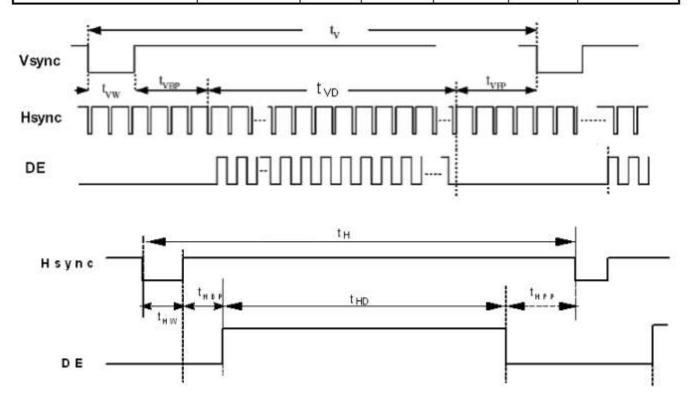


LVDS Data Input Format



Timing Table

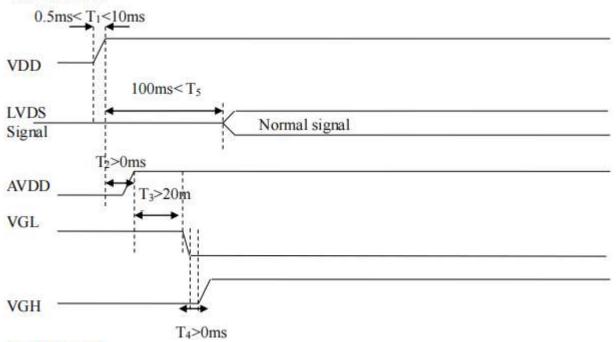
| *** | 0 | | Values | 240.00 | | |
|------------------------------------|--------|------|--------|--------|------|---------------------|
| Item | Symbol | Min. | Тур. | Max. | Unit | Remark |
| Clock Frequency | 1/Tc | 66.3 | 72.4 | 78.9 | MHz | Frame rate =60Hz |
| Horizontal display area tho | | | 1280 | | Tc | |
| HSYNC pulse width | thpw | 2 | | 40 | Tc | |
| HSYNC back porch(with pulse width) | tнвр | 88 | 88 | 88 | Tc | |
| HSYNC front porch | tHFP | 12 | 72 | 132 | Tc | (C) |
| Vertical display area | t∨o | | 800 | | tн | 6 |
| VSYNC pulse width | tvpw | 2 | - | 20 | tн | 2 |
| VSYNC back porch(with pulse width) | tvBP | 23 | 23 | 23 | tн | 55 |
| VSYNC front porch | tvfp | 1 | 15 | 49 | tн | |



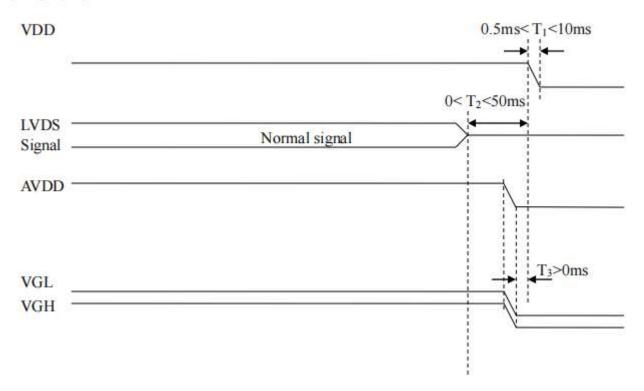
9. POWER SEQUENCE

To prevent the device damage from latch up and Improve subjective display effect, the power ON/OFF sequence shown below must be followed.

a. Power on:



b. Power off:



10. RELIABILITY TEST CONDITIONS

| No. | Test item | Test con | Inspection after test | |
|------|--|---|--|--|
| 10.1 | High temperature storage test | +80°C/240 hours | | |
| 10.2 | Low temperature storage test | -30°C/240 hours | | |
| 10.3 | High temperature operating test | +70°C/240 hours | | |
| 10.4 | Low temperature operating test | -20°C/240 hours | | Inspection after |
| 10.5 | Thermal Shock (non-operation) | -30°C ←→ +80°C/10 (30min.)(<30sec.) (3 | • | 2~4hours storage at room temperature, the sample should not have |
| 10.6 | High temperature high humidity test | +50°C*90% RH/240 | following defects : 1.Current changing | |
| 10.7 | Vibration test for Packaging | Frequency : 250 r/mi Amplitude : 1 inch Time: 45min | value before test and after test is 50% larger; 2. Function defect : | |
| | | Drop direction: 1 corner/3 edges/6 s | ides 10 times | Non-display,abnormal-d isplay,missing lines, Short lines,ITO |
| | | Packing weight(kg) | Drop height(cm) | corrosion; |
| 10.8 | Drop test for Packaging | <11 | 80±1.6 | 3.Visual defect : Air bubble in the LCD,Seal |
| | and the state of t | 11≦G<21 | 60±1.2 | leak,Glass crack. |
| | | 21≦G<31 50±1.0 | | |
| | | 31≦G<40 40±0.8 | | |
| 10.9 | ESD test | Air discharge: ±12K\ Contact discharge: ± | | |

Remark:

- 1. The test samples should be applied to only one test item.
- 2. Sample size for each test item is 3~5pcs.
- 3.For High temperature high humidity test, Pure water(Resistance>10M Ω) should be used.
- 4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.
- 5. Failure judgment criterion: Basic specification, Electrical characteristic, Mechanical characteristic, Optical characteristic.
- 6.After the reliability test, the product only guarantees operation, but don't guarantee all of the cosmetic specification.

11.INSPECTION CRITERION

Refer to 《Inspection Criterion for TFT Products-To customer》

12. HANDLING PRECAUTIONS

12.1 Mounting method

The TFT module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the TFT modules.

12.2 Caution of TFT module handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[recommended below] and wipe lightly:

- .lsopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns

Do not use the following solvent on the pad or prevent it from being contaminated :

- Soldering flux
- •.Chlorine (CI), Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The TFT module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to Vdd or Vss, do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

12.4 Packing

Module employ TFT elements and must be treated as such.

- Avoid intense shock and falls from a height.
- •.To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity.

12.5 Caution for operation

- •.It is an indispensable condition to drive TFT module within the specified voltage limit since the higher voltage then the limit cause the shorter TFT module life.
- •.An electrochemical reaction due to direct current causes TFT module undesirable deterioration, so that the use of direct current drive should be avoided.
- •.Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature TFT module how dark color in them. However those phenomena do not mean malfunction or out of order with TFT module, which will come back in the specified operation temperature.
- •.If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- •.A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
- •. Usage under the maximum operating temperature, 50%Rh or less is required.
- •.When fixed patterns are displayed for a long time, remnant image is likely to occur.

12.6 Storage

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- •.Storing in an ambient temperature 10°C to 30°C, and in a relative humidity of 45% to 75%. Don't expose to sunlight or fluorescent light.
- •.Storing in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- •.Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- •. Storing with no touch on polarizer surface by the anything else.

It is recommended to store them as they have been contained in the inner container at the time of delivery from

us.

12.7 Safety

- •.It is recommendable to crash damaged or unnecessary TFT module into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- •.When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

13. PRECAUTION FOR USE

- **13.1** A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.
- **13.2** On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.
- •. When a question is arisen in this specification.
- •. When a new problem is arisen which is not specified in this specifications.
- •.When an inspection specifications change or operating condition change in customer is reported to ODNA, and some problem is arisen in this specification due to the change.
- •. When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

14. PACKING SPECIFICATION

Please consult our technical department for detail information.

15. INITIALIZATION CODE

Please consult our technical department for detail information.

16. HSF COMPLIANCE

•.This products complies with ROHS 2011/65/EU and 2015/863/EU、REACH 1907/2006/EC requirements, and the packaging complies with 94-62-EC.